

ESDALC6V1-5P6

ESD protection for high speed interface

Features

- Diode array topology
- Low capacitance (12 pF typical)
- Lead-free package

Benefits

- Low capacitance uni-directional ESD protection.
- Low PCB space consuming, 2.5 mm² max. footprint
- Low leakage current
- High reliability offered by monolithic integration

Complies with the following standards

- IEC 61000-4-2 level 4:
 - 8 kV (contact discharge)
 - 15 kV (air discharge)
- MIL STD 883G-Method 3015-7: class3B
 - Human body model

Applications

Where transient overvoltage protection in ESD sensitive equipment is required, such as:

- Computers
- Printers
- Communication systems
- Cellular phone handsets and accessories
- Video equipment

Description

The ESDALC6V1-5P6 is a monolithic array designed to protect up to 5 lines against ESD transients.

The device is ideal for high speed interface applications where both reduced printed circuit board space and power absorption capability are required.

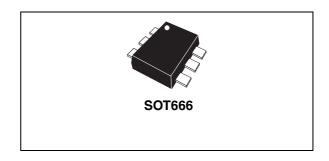
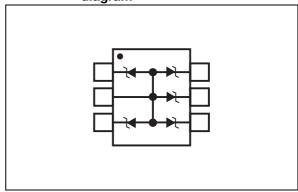


Figure 1. ESDALC6V1-5P6 functional diagram



Characteristics ESDALC6V1-5P6

1 Characteristics

Table 1. Absolute ratings $(T_{amb} = 25 \text{ °C})$

Symbol		Value	Unit		
V _{PP} ⁽¹⁾	Peak pulse voltage	IEC 61000-4-2 contact discharge IEC 61000-4-2 air discharge		± 8 ± 15	kV
P _{PP} (1)	Peak pulse power dissipation (8/20 μ s) T_j initial = T_{amb}			30	W
I _{PP}	Peak pulse current (8/20 µs)			2.5	Α
T _j	Junction temperature			125	°C
T _{stg}	Storage temperature range			-55 to +150	°C
T_L	Maximum lead temperature for soldering during 10 s			260	°C
T _{OP}	Operating temperature range -			- 40 + 125	°C

^{1.} For a surge greater than the maximum values, the diode will fail in short-circuit.

Table 2. Electrical characteristics ($T_{amb} = 25 \,^{\circ}C$)

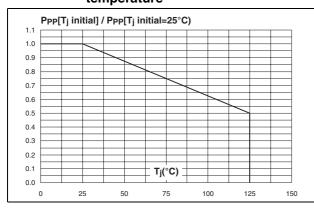
Symbol	Parameter			A I		
V _{RM}	Stand-off voltage			F		
V _{BR}	Breakdown voltage					
V _{CL}	Clamping voltage			,		
I _{RM}	Leakage current	$V_{CL}V_{BR}$ V_{RM}		√V _F		
I _{PP}	Peak pulse current	I _{RM}				→V
αΤ	Voltage temperature coefficient					
V _F	Forward voltage drop					
С	Capacitance					
R _d	Dynamic resistance	esistance				
Parameter	Test condition			Тур	Max	Unit
V _{RRM}	Reverse stand-off voltage				5	V
V _{BR}	I _R = 1 mA				7.2	V
I _{RM}	V _{RM} = 3 V				70	nA
V	Non repetitive peak pulse voltage	I _{PP} = 1 A			10	V
V _{CL}	(8/20 μs)	I _{PP} = 2.5 A			14	
V _F	I _F = 10 mA				1	V
R _d				2	3	Ω
αT ⁽¹⁾	I _R = 1 mA				5	10 ⁻⁴ /°C
С	$V_R = 0 \text{ V DC}, F = 1 \text{ MHz},$ $V_{OSC} = 30 \text{ mV rms}$			12	15	pF

^{1.} $\Delta V_{BR} = \alpha T x (T_{amb} - 25 ^{\circ}C) x V_{BR} (25 ^{\circ}C)$

ESDALC6V1-5P6 Characteristics

Figure 2. Relative variation of peak pulse power versus initial junction temperature

Figure 3. Peak pulse power versus exponential pulse duration $(T_i initial = 25 °C)$



Ppp(W)

1000

tp(μs)

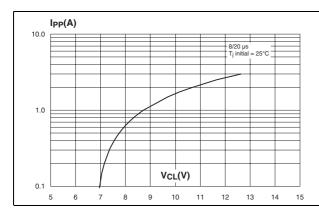
100

100

100

Figure 4. Clamping voltage versus peak pulse current (typical values)

Figure 5. Relative variation of leakage current versus junction temperature (typical values)



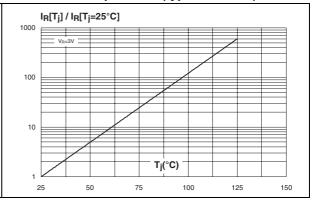
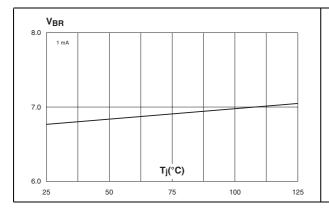
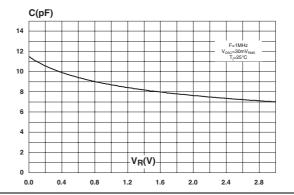


Figure 6. Breakdown voltage versus initial junction temperature

Figure 7. Junction capacitance versus reverse voltage applied (typical values)

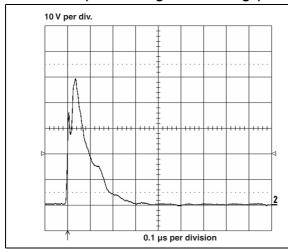




Characteristics ESDALC6V1-5P6

Figure 8. ESD response to IEC 61000-4-2 (air discharge +15 kV surge)

Figure 9. ESD response to IEC 61000-4-2 (air discharge -15 kV surge)



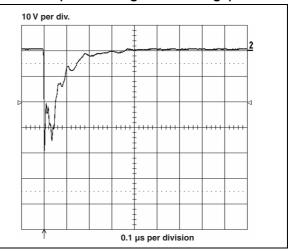
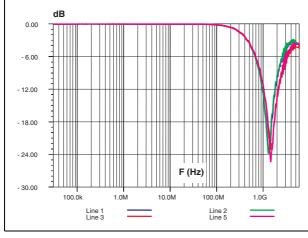
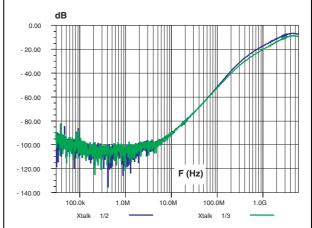


Figure 10. Frequency response curves - all lines together

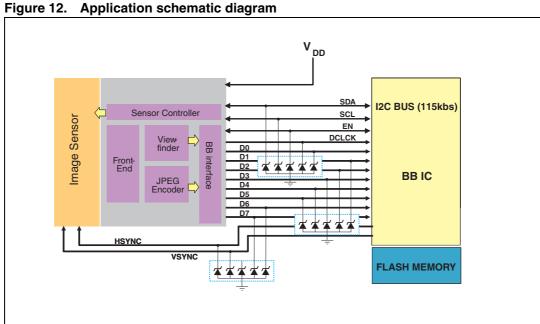
Figure 11. Crosstalk response curves - 1/2 and 1/3



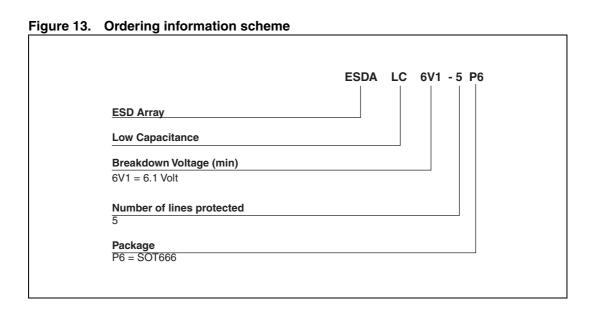


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Application information 2



Ordering information scheme 3



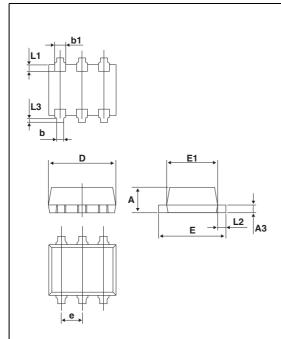
Package information ESDALC6V1-5P6

4 Package information

Epoxy meets UL 94, V0

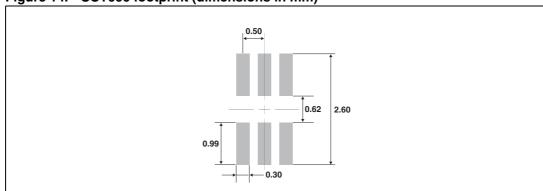
In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

Table 3. SOT666 dimensions



	Dimensions						
Ref.	Millimete		ers I		Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.	
Α	0.45		0.60	0.018		0.024	
А3	0.08		0.18	0.003		0.007	
b	0.17		0.34	0.007		0.013	
b1	0.19	0.27	0.34	0.007	0.011	0.013	
D	1.50		1.70	0.059		0.067	
Е	1.50		1.70	0.059		0.067	
E1	1.10		1.30	0.043		0.051	
е		0.50			0.020		
L1		0.19			0.007		
L2	0.10		0.30	0.004		0.012	
L3		0.10			0.004		

Figure 14. SOT666 footprint (dimensions in mm)



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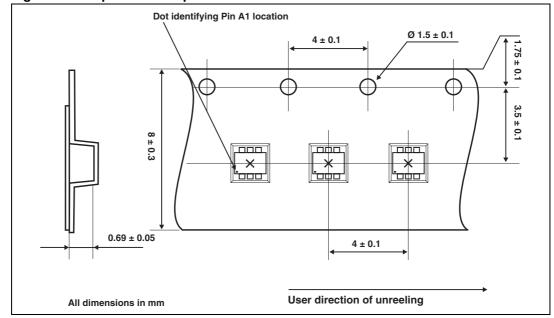


Figure 15. Tape and reel specifications

Note:

Product marking may be rotated by 90° for assembly plant differentiation. In no case should this product marking be used to orient the component for its placement on a PCB. Only pin 1 mark is to be used for this purpose.

5 Ordering information

Table 4. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
ESDALC6V1-5P6	J ⁽¹⁾	SOT666	2.9 mg	3000	Tape and reel

^{1.} The marking can be rotated by 90° to diferentiate assembly location

6 Revision history

Table 5. Document revision history

Date	Revision	Description of changes
29-May-2007	1	First issue.
30-Jul-2007	2	Upgrade V _{CL} from 8 V to 10 V and from 9.5 V to 14 V.
15-Nov-2007	3	Reformatted to current standards. Marking changed to J in <i>Table 4</i> . Notes on marking rotation added to <i>Table 4</i> and <i>Figure 15</i> .

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